

LINEAR TECHNOLOGY MATERIALS DECLARATION

1t3089edf#pbf

(Engineering Calculation)

DFN 4mm X 4mm Exp. Pad

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TOTAL MASS (g) : 0.036803

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001909	1000000	51870.3164062		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.012129	975000	329562.625		
		Iron (Fe)	7439-89-6	0.000291	23400	7906.89404297		
		Phosphorus (P)	7723-14-0	0.000010	800	271.714569092		
		Zinc (Zn)	7440-66-6	0.000010	800	271.714569092		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.012440	1000000	338012.9375		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000580	1000000	15768.3339844		
		External Plating Total:				0.000580	1000000	15768.3339844
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000278	1000000	7553.66552734		
Internal Plating Total:				0.000278	1000000	7553.66552734		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000356	800000	9673.0390625		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000089	200000	2418.25976562		
Die Attach Total:				0.000445	1000000	12091.2998047		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.002739	130000	74422.6171875		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.018120	860000	492346.84375		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000211	10000	5733.17822266		
		Encapsulation Total:				0.021070	1000000	572502.625
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000081	1000000	2200.88818359		
					TOTAL MASS (g) :	0.036803		